

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.



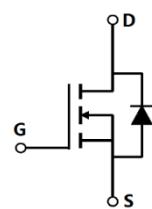
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Parameter	Value	Unit
$V_{DS, \min} @ T_{j(\max)}$	650	V
I_D, pulse	24	A
$R_{DS(ON)}, \text{max} @ V_{GS}=10V$	580	
Q_g	9.5	nC

Product Name	Package	Marking
OSG60R580PF	TO220	OSG60R580P



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C _{iss}		464		pF	V _{GS} =0 V, V _{DS} =50 V, Hz
Output capacitance	C _{oss}		38.3		pF	
Reverse transfer capacitance	C _{rss}		1.47		pF	
Turn-on delay time	t _{d(on)}		18		ns	V _{GS} =10 V, V _{DS} =380 V, R _G =25 I _D =8 A
Rise time	t _r		18		ns	
Turn-off delay time	t _{d(off)}		27		ns	
Fall time	t _f		22		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge						

Electrical Characteristics Diagrams

Figure 1. Typ. output characteristics	Figure 2. Typ. transfer characteristics
Figure 3. Typ. capacitances	Figure 4. Typ. gate charge
Figure 5. Drain-source breakdown voltage	Figure 6. Drain-source on-state resistance

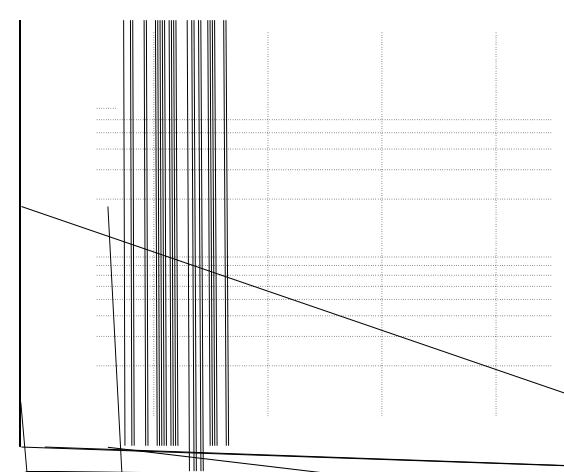


Figure 7. Forward characteristic of body diode

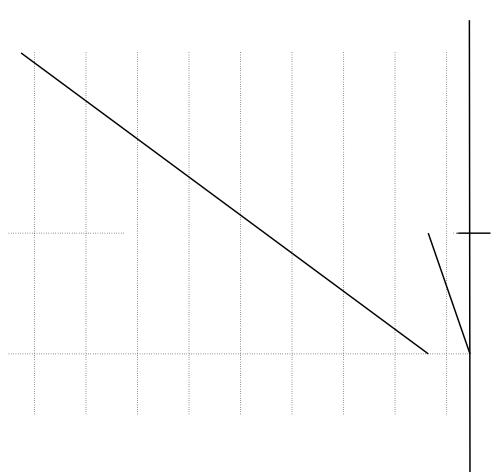


Figure 8. Drain-source on-state resistance

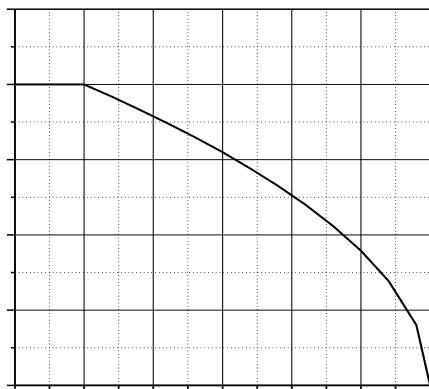


Figure 9. Drain current

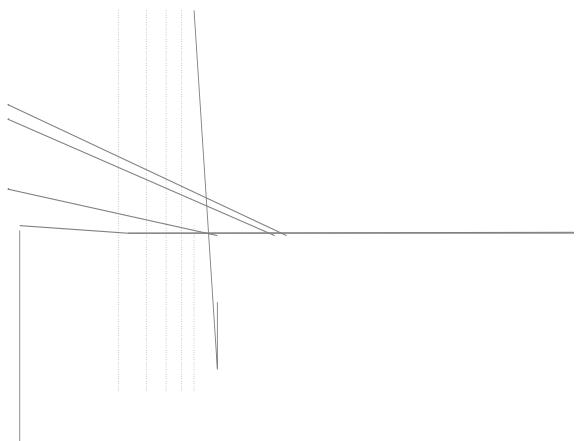


Figure 10. Safe operation area $T_c=25\text{ }^\circ\text{C}$

Test circuits and waveforms

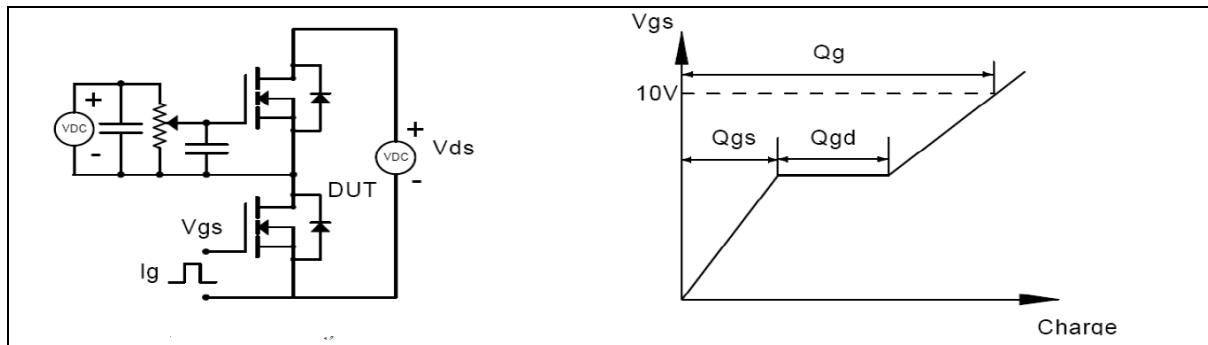


Figure 1. Gate charge test circuit & waveform

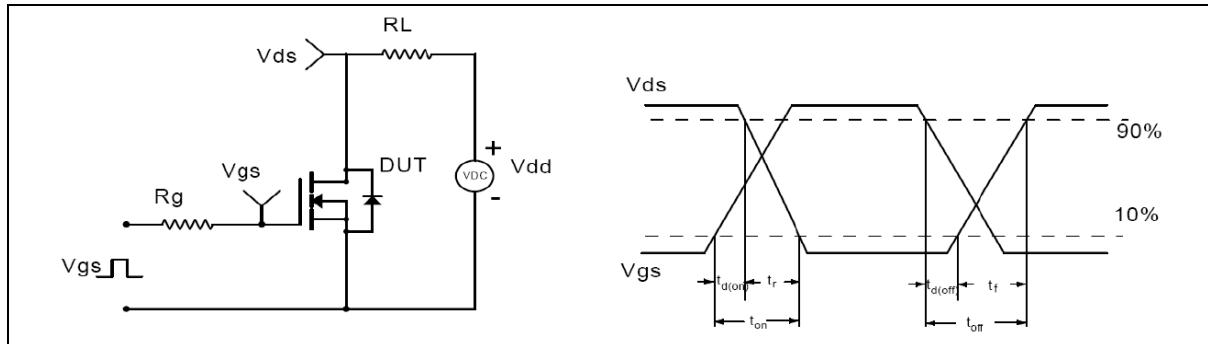


Figure 2. Switching time test circuit & waveforms

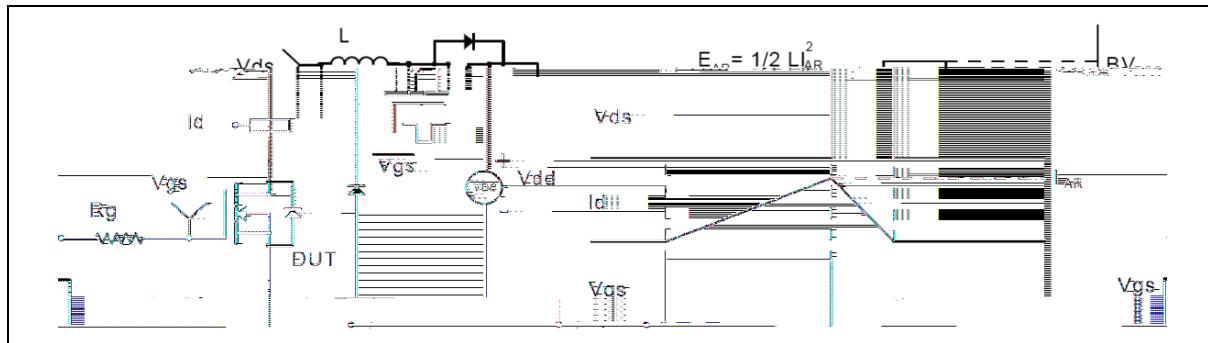


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

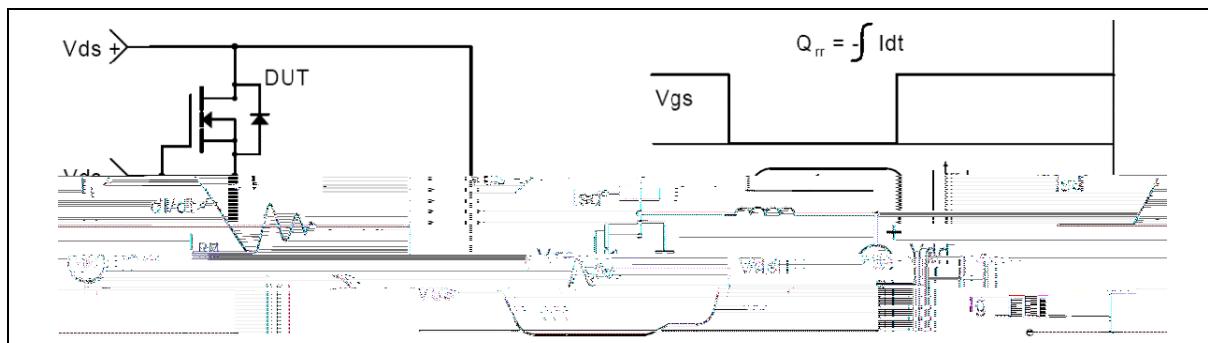
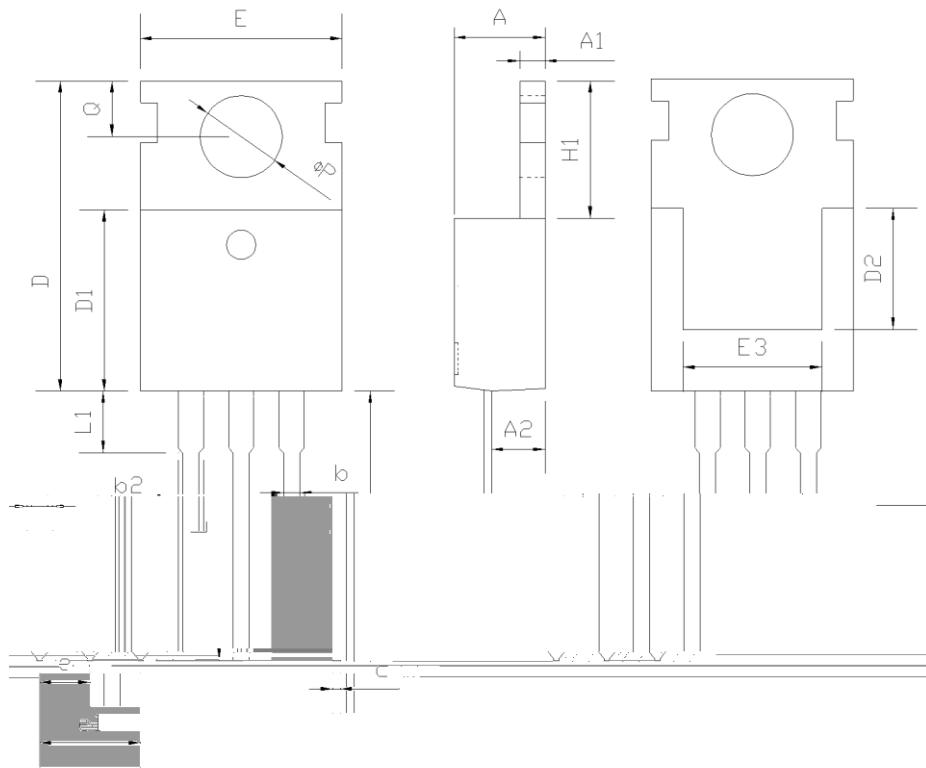


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



Symbol	mm		
	Min	Nom	Max
A	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54BSC		
e1	5.08BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
	3.40	3.60	3.80
Q	2.60	2.80	3.00

Version1: TO220-P package outline dimension

Ordering Information

Package Type	Units/Tube	Tubes / Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO220-P	50	20	1000	6	6000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG60R580PF	TO220	yes	yes	yes